

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

Ki-Don Lee, et al.

Serial No: TBD

Filed: Herewith

For: Mechanical Cooling Fin for Interconnects

TI-34867

Examiner: TBD

Art Unit: TBD

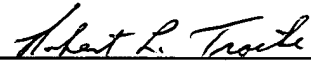
PRELIMINARY AMENDMENT

Assistant Commissioner for Patents

Washington, D. C. 20231

Dear Sir:

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 10/17/03
Robert L. Troike, Reg. No. 24,183 Date

This application claims priority under 35 USC 119 (e)(1) of provisional application number 60/436,660 filed 12/30/02.

Prior to the examination of the above-identified application, please amend the specification by inserting before the first line the sentence:

--This application claims priority under 35 USC § 119(e)(1) of provisional application number 60/436,660 filed 12/30/02.--

Respectfully submitted,



Robert L. Troike
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